

HD1760JL

PRELIMINARY DATA

High Voltage NPN Power Transistor for High Definition and New Super-Slim CRT Display

Features

- STATE-OF-THE-ART TECHNOLOGY: DIFFUSED COLLECTOR "ENHANCED GENERATION" EHVS1
- WIDER RANGE OF OPTIMUM DRIVE CONDITIONS
- LESS SENSITIVE TO OPERATING TEMPERATURE VARIATION

Applications

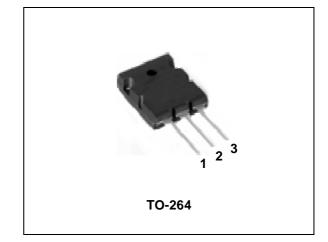
 HORIZONTAL DEFLECTION OUTPUT FOR DIGITAL TV, HDTV AND HIGH -END MONITORS

Description

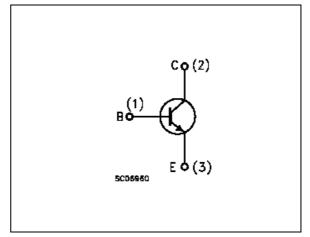
The device uses a Diffused Collector in Planar technology which adopts "Enhanced High Voltage Structure" (EHVS1) that was developed to fit High-Definition CRT displays.

The new HD product series features improved silicon efficiency, bringing updated performance to Horizontal Deflection output stages.

Order codes



Internal Schematic Diagram



Part Number	Marking	Package	Packing
HD1760JL	HD1760JL HD1760JL		TUBE

1 Electrical ratings

Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage (V _{BE} = 0)	1700	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	800	V
V _{EBO}	Emitte-Base Voltage (I _C = 0)	10	V
۱ _C	Collector Current	36	A
I _{CM}	Collector Peak Current (t _P < 5ms)	54	Α
I _B	Base Current	18	A
I _{BM}	Base Peak Current (t _P < 5ms)	27	А
P _{TOT}	Total dissipation at $T_c = 25^{\circ}C$	200	W
T _{STG}	Storage Temperature	-65 to 150	°C
Τ _J	Max. Operating Junction Temperature	150	°C

Table 1. Absolute Maximum Rating

Table 2. Thermal Data

Symbol	Parameter	Value	Unit
R _{thJC}	Thermal Resistance Junction-Case Max	0.625	°C/W



2 Electrical Characteristics

 $(T_{CASE} = 25^{\circ}C; unless otherwise specified)$

 Table 3.
 Electrical Characteristics

Symbol	Parameter	Parameter Test Conditions		Тур.	Max.	Unit
I _{CES}	Collector Cut-off Current (V _{BE} = 0)	$V_{CE} = 1700V$ $V_{CE} = 1700V$ $T_{C} = 125^{\circ}C$			0.2 2	mA mA
I _{EBO}	Emitter Cut-off Current (I _C = 0)	V _{EB} = 5V			10	μA
V _{CEO(sus)} Note: 1	Collector-Emitter Sustaining Voltage (I _B = 0)	I _C = 10mA	800			V
V _{EBO}	Emitter-Base Voltage (I _C = 0)	I _E = 10mA	10			V
V _{CE(sat)} Note: 1	Collector-Emitter Saturation Voltage	I _C = 18A I _B = 4.5A			2	V
V _{BE(sat)} Note: 1	Base-Emitter Saturation Voltage	I _C = 18A I _B = 4.5A			1.5	V
h _{FE}	DC Current Gain	$I_{C} = 2A$ $V_{CE} = 5V$ $I_{C} = 18A$ $V_{CE} = 5V$	5	30	8.5	
t _s t _f	INDUCTIVE LOAD Storage Time Fall Time	$\begin{split} I_{C} &= 12A & f_{h} = 32 \text{ KHz} \\ I_{B(on)} &= 1A & I_{B(off)} = -6.9A \\ V_{CE(fly)} &= 1340V & V_{BE(off)} = -2.7V \\ I_{BB(on)} &= 0.8 \mu \text{H} \end{split}$		2.6 300		μs ns
t _s t _f	INDUCTIVE LOAD Storage Time Fall Time	$\begin{split} I_{C} &= 8A & f_{h} = 100 \text{kHz} \\ I_{B(on)} &= 1.3A & I_{B(off)} = -5.8A \\ V_{CE(fly)} &= 1300 \text{V} & V_{BE(off)} = -2.7 \text{V} \\ I_{BB(on)} &= 0.25 \mu \text{H} \end{split}$		2 110		μs ns

Note: 1 Pulsed duration = $300 \ \mu s$, duty cycle $\leq 1.5\%$.



3 Test circuit

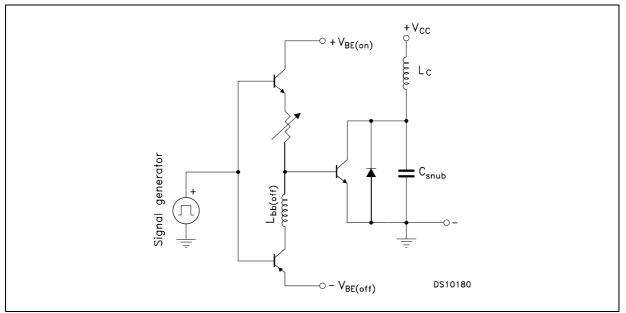
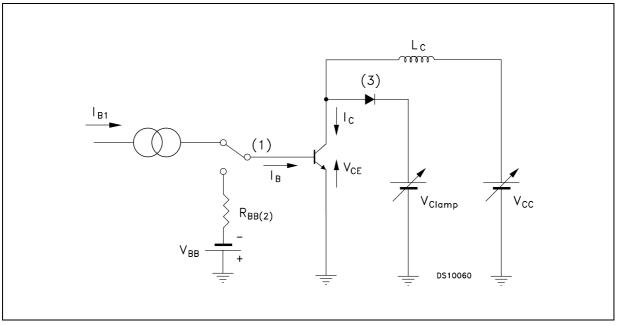


Figure 1. Power Losses and Inductive Load Switching Test Circuit

Figure 2. Reverse Biased Safe Operating Area Test Circuit



4 Package Mechanical Data

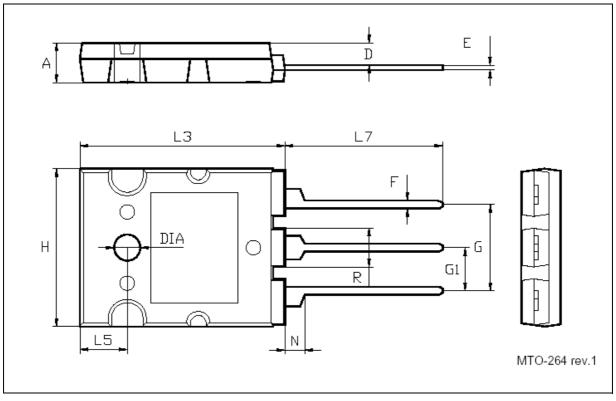
In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



DIM.	mm.			inch			
DIWI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
A	4.80		5.20	0.189		0.205	
D	2.50		3.10	0.098		0.122	
E	0.50	0.60	0.85	0.020	0.24	0.033	
F	0.90	1.00	1.25	0.036	0.039	0.049	
G	10.30		11.50	0.406		0.453	
G1		5.45			0.215		
н	19.80		20.20	0.780		0.795	
L3	25.80		26.20	1.016		1.031	
L5	5.80		6.20	0.228		0.244	
L7	19.50		20.50	0.768		0.807	
Ν	2.30		2.70	0.091		0.106	
R	4.7		5.10	0.185		0.201	
DIA	3.10		3.50	0.122		0.138	

Table 4. TO-264 Mechanical Data

Figure 3. TO-264 Drawing



5 Revision History

Date	Revision	Changes		
17-Oct-2005	1	Initial release.		
03-Nov-2005	2	h _{FE} value has been changed on <i>Table 3</i>		



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